

Process Qualification Report

Reliability By Design

Qualification Description:

The information contained herein represents proof of Reliability and Performance of the baseline process technology listed below in accordance with the Qualification Plan and test methods referenced in Section 8.0, after exposure to a variety of environments (electrical, thermal, humidity, etc) and mechanical events that may occur during installation and operational lifetime of the product. Upon conclusion of the testing the product continued to operate within specification limits, demonstrating its capability of reliable operation throughout its lifetime.

The purpose of this report is to present Qualification Test results of the of referenced process technology. The Pericom product data presented in this report qualifies all products manufactured using the exact semiconductor materials and processing techniques used in the baseline process and its off-shoot processes. The report describes the qualification test program, procedures used, criteria enforced (at the time of product validation), and the resulting test data obtained during the Qualification Test. The materials and processing techniques used in the baseline process are incorporated into the off-shoot processes, so the quality/integrity of the baseline and off-shoots (i.e.: 2PxM, 1PxM) processes will be equivalent.

Lot Background Information:

Qual Test Date:	30-Nov-16 updated 14-Mar-2017
Process Technology:	0.13um 1P4M
Foundry & Code:	SMIC (I)
Qual Test Number:	QDI16005 SMIC WLR (QR-2011v0) SMIC WLR (QR-2033v0)

By Ext. Process:	0.13um 1PxM
Qual Vehicle:	PI2EQX6804-ANJE R037 TQV 0.13um 1P8M R037A TQV 0.13um 1P8M

Pericom's Qualification Test Results:

Stress Test	Test Procedure	Test Conditions	Duration	# of Lots	Samples per Lot	Results Pass/Fail
Dynamic High Temp	JESD22-A108	1000 hrs 1.25V 125°C	168 hrs	3	80	240 / 0
Operating Life (DHTOL)		1000 hrs 1.25V 125°C	500 hrs	3	80	240 / 0
(PI2EQX6804-ANJE)		1000 hrs 1.25V 125°C	1000 hrs	3	80	240 / 0
Dynamic High Temp	JESD22-A108	1000 hrs 1.2~1.4V 125°C	168 hrs	3	129	387 / 0
Operating Life		1000 hrs 1.2~1.4V 125°C	500 hrs	3	129	387 / 0
(SMIC WLR R037 TQV)		1000 hrs 1.2~1.4V 125°C	1000 hrs	3	129	387 / 0
Dynamic High Temp	JESD22-A108	1000 hrs 1.2~1.4V 125°C	168 hrs	3	129	387 / 0
Operating Life		1000 hrs 1.2~1.4V 125°C	500 hrs	3	129	387 / 0
(SMIC WLR R037A TQV)		1000 hrs 1.2~1.4V 125°C	1000 hrs	3	129	387 / 0
	ELF based on 1,014 units after 168 hrs	ELF Rate (55C, 0.7 eV, 2.5V, 60% CL)		60.1		
	FIT based on 1,014 units after 1,000 hours	FIT Rate (55C, 0.7 eV, 2.5V, 60% CL)		10.1		
		Calculated MTBF (hours)		99,083,429		
Temp Cycle Test	JESD22-A104	-65°C to 150°C, 500cyc	100 cycles	3	80	240 / 0
(PI2EQX6804-ANJE)		-65°C to 150°C, 500cyc	500 cycles	3	80	240 / 0
Temp Cycle Test	JESD22-A104	-65°C to 150°C, 1000cyc	500 cycles	3	45	135 / 0
(SMIC WLR R037A TQV)		-65°C to 150°C, 1000cyc	1000 cycles	3	45	135 / 0
High Temp Storage (HTS)	JESD22-A103	1000hrs, 0V, 150°C	168 hrs	3	80	240 / 0
(PI2EQX6804-ANJE)		1000hrs, 0V, 150°C	500 hrs	3	80	240 / 0
		1000hrs, 0V, 150°C	1000 hrs	3	80	239 / 0 ⁽¹⁾
High Temp Storage (HTS)	JESD22-A103	1000hrs, 0V, 150°C	168 hrs	3	45	135 / 0
(SMIC WLR R037A TQV)		1000hrs, 0V, 150°C	500 hrs	3	45	135 / 0
		1000hrs, 0V, 150°C	1000 hrs	3	45	135 / 0
Latch Up Test	EIA JESD78	Pass, Report available by Device				
ESD-HBM Test	JESD22-A114	Pass, Report available by Device				

⁽¹⁾ 1 unit cannot be measured with missing BGA ball due to handling. The unit is removed from the data

Qualification by Extension Information:

It is valid to use the reliability data of a particular process technology and apply to all products within this process technology family. All parts within the same family are designed to the same rules (layout & electrical), and manufacturing is controlled by SPC. Within a product family, a device can only be fabricated on one process technology option.

If there are any questions about this qualification, please contact Quality Support at: customerquestion@diodes.com

Approval: SIGNATURE ON FILE Raul Aman, Director - Quality Assurance Diodes Incorporated

